

smoothing mechanism having a resin receiving plate whose front end has a doctor blade shape at a position facing the workpiece, having a structure which can linearly move in the direction vertical to the axis center of the workpiece and adjust a tilt angle, and an exposing mechanism capable of applying high-intensity ultraviolet light to liquid-state photosensitive resin applied to the outer periphery of the workpiece and smoothed and linearly moving the applying means in the direction vertical to the axis center of the workpiece.

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Page 23, replace the paragraph beginning on line ³/~~2~~ with the following amended paragraph:

Furthermore, the apparatus for manufacturing a relief material for seamless printing according to ~~claim~~ item 17 of the present invention is characterized in that the resin receiving plate has a resin flow preventive movable dam capable of linearly moving in the axis center direction of the workpiece at at least one end in ~~claim~~ item 16.

Page 23, replace the paragraph beginning on line 11 with the following amended paragraph:

Furthermore, the apparatus for manufacturing a relief material for seamless printing according to ~~claim~~ item 18 of the present invention further comprises a working-tool holding pedestal mechanism capable of linearly moving a working-tool holding pedestal in the axis center direction of the workpiece and further includes at least one of a cutting mechanism, grinding mechanism, and polishing mechanism capable of linearly moving the working tool fixed by the holding pedestal in the direction vertical to the axis center of the workpiece in ~~claim~~ item 16 or 17.

modifying step for applying a surface modifying agent for modifying the surface of a relief image layer of the workpiece while rotating the workpiece to the relief image layer and drying the agent in ~~claim~~ item 13.

Page 21, replace the paragraph beginning on line 11 with the following amended paragraph:

Furthermore, the method for manufacturing a relief material for seamless printing according to claim 15 of the present invention is characterized by performing forcible heating and drying while applying the surface modifying agent to the relief image layer in the surface modifying step in ~~claim~~ item 12.

Page 21, replace the paragraph beginning on line 18 through page ²¹/~~22~~, line 17 with the following amended paragraph:

Furthermore, the apparatus for manufacturing a relief material for seamless printing according to ~~claim~~ item 16 of the present invention is an apparatus for manufacturing a relief material for seamless printing using a liquid-state photosensitive resin, which is characterized by including a workpiece continuous rotating mechanism having a structure capable of rotating by integrally connecting a workpiece to whose outer periphery the liquid-state photosensitive resin is applied, a resin supplying mechanism according to any one of a first resin supplying mechanism having a resin supplying nozzle integrated with a vessel for housing the liquid-state photosensitive resin and capable of linearly moving in the axis center direction of the workpiece, and a second resin supplying mechanism having at least one or more resin supplying nozzles in accordance with a desired applied width on a resin supplying header pipe-connected with the vessel for housing the liquid-state photosensitive resin, a resin applying